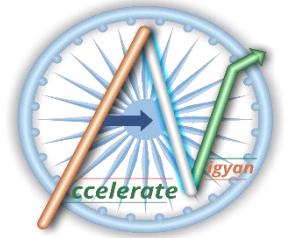




**KARYASHALA** Scheme - A **SERB** initiative



On

## High End Workshop on DOE, Material Characterization and Advanced Manufacturing Techniques

**Duration:** September 20-26, 2021

**Organised by**

**Department of Mechanical Engineering,**

**Indian Institute of Information Technology, Design and Manufacturing, Jabalpur**

### **Undertaking from the Student Applicant**

1. I hereby provide my consent to participate in the High-End Workshop titled “Research Methodology & Scientific Communication in Mechanical Engineering” Organised by PDPM-IIITDM Jabalpur upon selection.
2. I vouch for participating in this workshop whole-heartedly and attend all the sessions, sincerely with utmost dedication.
3. I shall also be responsible and attentive to involve myself during the discussion/interaction session.
4. I am aware that it is mandatory to attend all the sessions and compulsorily qualify the course assessment in order to successfully avail the certification.
5. I understand that the videos and lecture material supplied during this workshop are only for educational/academic purpose.
6. Uploading/hosting/sharing on any platform shall be unlawful on the grounds of Intellectual Property Rights.
7. Any Proxy participation in the sessions/exam shall invite immediate cancellation of his/her candidature and same shall be reported to parent institution.
8. I understand to ensure proper internet connectivity and stable connection, necessary software/application like WebEx/G Meet/Microsoft Teams for video conferencing with camera ON. Any support in this regard is to be sought from the applicant’s parent Institution. The organising institute shall not be liable for the same.
9. It is highly advisable to use desktop or laptop PC and avoid use of smartphone, since the workshop involves Tutorial & Hands-on-sessions.
10. I agree to abide by any other terms and conditions of Organizing Institute and DST-SERB.

Name of the Applicant :  
Gender & Age :  
Programme (Ph.D. /M Tech) :  
Institution/University :  
Date :  
Place :  
Signature of the Applicant :